

Packages and Thermal Characteristics

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Quality Assurance and Reliability

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IBIS Files ([Accessed from DataSource CD-ROM—directory: IBIS_files](#))

BSDL Files ([Accessed from DataSource CD-ROM—directory: BSDL_files](#))

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Xcell Journal:

The Authoritative Journal for Programmable Logic

Xcell Journal Archives ([Web Browser required](#))**Inside Out Columns****TechXclusive Articles:**

Exclusive articles from the experts on the latest design trends

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